SERIES, Commercial Space 50 KRad/Si TID min. | 75 MeV cm²/mg min.

Symmetry

min / max

(%)

40/60

40/60

40/60

40/60

Crystal Oscillator | 3.3V | CMOS | 5x3.2mm Ceramic SMD | SmallSat-CubeSat



5x3.2 mm Ceramic SMD Package

Features

S

CODE

13

16

19

23

Electrical

C

CODE

11

14

17

21

SPECIFICATIONS

Screening Code

CODE

12

15

18

22

Hi-Rel Design and Manufacture

Supply

Current

@ 3.3V ±10%

(mA)

20

25

30

35

- Customer Support & Service
- Manufactured in the USA

Frequency

Range

(MHz)

48 to 64.9

65 to 79.9

80 to 94.9

95 to 130

- Proven High Shock Crystal Support
- High-Shock & Vibration Configuration
- ECCN EAR 99 ■ Small Hi-Rel Package

-40°C to

+105°C

(ppm)

CODE

C

±60

±60

±60

±60

-40°C to

+85°C

(ppm)

CODE

D

±50

±50

±50

±50

code

Frequency Stability Vs. Temperature

-55°C to

+125°C

(ppm)

CODE

В

±75

±75

±75

±75

■ Mission Success | Life 6 Months to 5 Years

Aging

per year

max <u>1</u>/

(ppm)

±10

±10

±10

+10

-55°C to

+125°C

(ppm)

CODE

A

±100

±100

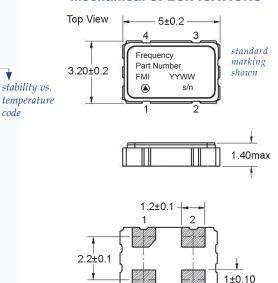
±100

±100

US Manufacture

- **Design & Configuration Control**
- Radiation Test Data Available upon Request

Mechanical SPECIFICATIONS



See reverse side for screening details

CMOS Output, 15 pF Load Output Voltage - Logic "0" is Vcc x 0.1 Vdc Output Voltage - Logic "1" is Vcc is 0.9 Vdc

Rise/Fall

Time

(tr/tf) max

(nsec)

3

2

2

2

Start-up Time: 10 msec max

1/ Frequency Aging Limit

Max change over 30 days ±1.5 ppm Projected max change for 1 year after 30 days

±10 ppm

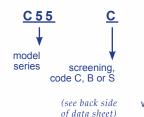
Please Contact Us for Specification Options that are Outside of or beyond those Shown in the Table Above

| Standard PAD |
|--|
| CONFIGURATION |
| * Enable, Logic 1 Disable, Logic 0 |
| Terminate any unused pads, (they are not terminated internally). |

| Pin Number | Function |
|------------|----------------------------|
| 1 | Ourput Enable (Tri-state)* |
| 2 | Ground (case) |
| 3 | Output |
| 4 | Supply V (Vcc) |

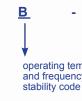
How To ORDER

MIL-STD-790 Certified QPL per MIL-PRF-55310 ISO 9001:2015 Pb-free RoHS Certified





range



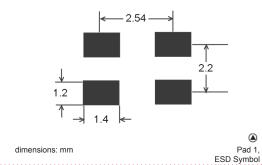


example:

C55C14B-66M00000

Recomended Land Pattern

- 2.54±0.1



FREQUENCY MANAGEMENT | International 15302 Bolsa Chica Street

Ph. 714 373 8100 Fx. 714 373 8700

Bottom View



C55

Lower than 3.3 Volt versions of our 5x3.2 mm SMD Crystal Oscillator for Commercial Satellite are available, please inquire!



| Screening | Method Options: | С | В | | |
|--|--|---|---|---|---|
| Non-Destruct Bond Pull | MIL-STD-883, Method 2023 | • | | T | Ī |
| Internal Visual | MIL-STD-883, Method 2017 | • | • | | |
| Stabilization (Vacuum) Bake MIL-STD-883, Method 1008, Condition C, 150°C, 24 hours min | | | • | | |
| Temperature Cycling | MIL-STD-883, Method 1010, Condition B, 10 Cycles | • | • | | |
| Constant Acceleration | MIL-STD-883, Method 2001, Condition A (Y1 only, 5000 g's) | | • | Τ | |
| PIND Test | MIL-STD-883, Method 2020, Condition B, 5 passes max | | | | |
| Seal: Fine Leak | MIL-STD-883, Method 1014, Condition A1 | | | | |
| | MIL-STD-202, Method 112, Condition C, 111A | | • | | |
| Seal: Gross Leak | MIL-STD-202, Method 112, Condition D | • | | | |
| lectrical Test Functional Test Only at +23°C | | • | • | | |
| Marking & Serialization MIL-STD-1285 | | • | • | | |
| Electrical Test | Nominal Vcc & Extremes and Nominal Temp and Extremes | | • | | |
| Burn-in (load) | +125°C, Nominal Supply Voltage and Burn-in load, 160 hours min | | • | | |
| Burn-in (no-load) | urn-in (no-load) +125°C, Nominal Supply Voltage and Burn-in load, 48 hours min | | | | |
| Interim Electrical | Functional Test Only | | | | |
| Burn-in (load) | +125°C, Nominal Supply Voltage and Burn-in load, 160 hours min | | | | |
| Final Electrical Test a) Input current, output frequency, output waveform, are tested at +23°C ±2°C b) Frequency stability is tested over the specified temperature range; at both extremes and at +25°C at a minimum of 5 temperature increments note: Recording of test data is by lot # and then serial # | | | | | |
| Radiography | MIL-STD-883, Method 2012 | | | | |
| Frequency Aging | MIL-PRF-55310, +70°C Condition | | | | |
| Frequency/Temperature Stability | MIL-PRF-55310, Over temperature extremes, 20 points equally spaced | | | | |
| External Visual & Mechanical | MIL-STD-883, Method 2009 | • | | | |

| • | C Series Designed Specifically for Lower-cost Space Missions |
|----------|--|
| SmallSat | : CubeSat |
| | |

| Environmental | COMDI | IANCE |
|---------------|-------|-------|
| | | |

| Environmental | Specification | Method | Condition | |
|-----------------------|---------------|-------------|--------------|-----------------------------|
| Vibration – Sine | MIL-STD-202 | Method 204 | Condition D | 20g, 10 to 2 KHz |
| Vibration – Random | MIL-STD-202 | Method 214 | Condition 1 | 30g rms, 10 to 2 KHz Random |
| Shock | MIL-STD-202 | Method 213 | Condition I | 100g, 6 ms, F:1500, 0.5 ms |
| Seal Test | MIL-STD-883 | Method 1014 | Condition A1 | Fine Leak |
| Seal Test | MIL-STD-883 | Method 1014 | Condition C1 | Gross Leak |
| Temperature Cycling | MIL-STD-883 | Method 1010 | Condition B | 10 Cycles Minimum |
| Constant Acceleration | MIL-STD-883 | Method 2001 | Condition A | 5000g, Y1 Axis |
| Thermal Shock | MIL-STD-202 | Method 107 | Condition B | |

continued...

| Environmental | Specification | Method | Condition |
|------------------------------|---------------|-------------|----------------------|
| Ambient Pressure | MIL-STD-202 | Method 105 | Condition C |
| Resistance to Soldering Heat | MIL-STD-202 | Method 210 | Condition C |
| Moisture Resistance | MIL-STD-202 | Method 106 | with 7B Sub-cycle |
| Salt Atmosphere (corrosion) | MIL-STD-883 | Method 1009 | Condition A (24 hrs) |
| Terminal Strength | MIL-STD-202 | Method 211 | Test Condition D |
| Solderability | MIL-STD-883 | Method 2003 | |
| Resistance to Solvents | MIL-STD-202 | Method 215 | |

note: other options, screening levels and custom test plans available.

MIL-STD-790 Certified QPL per MIL-PRF-55310 ISO 9001:2015 Pb-free RoHS Certified

Military Reference Specifications

MIL-PRF-55310 Oscillators, Crystal Controlled, General Specification For
MIL-PRF-38534 Hybrid Microcircuits, General Specification For
MIL-STD-202 Test Method Standard, Electronic and Electrical Components
Test Methods and Procedures for Microelectronics
MIL-STD-1686 Electrostatic Discharge Control Program for Protection of
Electrical and Electronic Parts, Assemblies and Equipment

Materials

- 1. Package Materials: Ceramic, Alumina 90% min
- 2. External Lead Plating Material: Gold plated Kovar, 0.15 μm (60 μ inch) min, over 2.0 μm (80 μ inch) min Nickel

Products for Space Applications

Contact us for assistance with your specification. We will provide you with the technical support and the required documentation.

Issue 11_12192023



Ph. 714 373 8100 Fx. 714 373 8700